A-V/2801 PTO/SB/21 (08-00)

TDANCMITTAL		Application Number	09/678,414		
* TRANSMITTAI		Filing Date	October 2, 2000		
FORM		First Named Inv. ntor	David W. Carlson 2823		
(to be used for all correspondence after	initial filing)	Group Art Unit (
		Examiner Name	B. Kebede		
Total Number of Pages in This Submissio	n 18	Attorney Docket Number	100-13601 (P04797-C1)		
	ENCLO	SURES (check all that apply)			
Fee Transmittal Form (in duplicate)		ment Papers Application)	After Allowance Communication Group		
Eee Attached (check for \$168)	☐ Drawin	g(s)	Appeal Communication to Board Appeals and Interferences		
Amendment/Response	Licensi	ng-related Papers	Appeal Communication to Grou (Appeal Notice, Brief, Reply Brief)		
After Final (Response)		Routing Slip (PTO/SB/69) companying Petition	Proprietary Information		
Affidavits/declaration(s)	ı —	to Convert to a onal Application	Status Inquiry		
Extension of Time Request		of Attorney, Revocation e of Correspondence Address	Other Enclosure(s) (please identify below):		
Express Abandonment Request	Termina	al Disclaimer	Return Receipt Postcard Certificate of Mailing		
	Reques	t for Refund	,		
Information Disclosure Statement	CD, Nu	mber of CD(s)			
Certified Copy of Priority Document(s)	Remar	Please charge any r ks Deposit Account No transmittal is attach	ecessary fees or credit overpayment 502305. <u>A duplicate copy of this</u> ed for this purpose.		
Response to Missing Parts/ Incomplete Application					
Response to Missing Parts under 37 CFR 1.52 or 1.53			AUC		
SIGNA	ATURE OF A	PPLICANT, ATTORNEY, C	R AGENT 5		
Firm or Individual name Mark C. Pickering	, Reg. No. 36,	2003			
Signature Muc	C. Pii C				
Date August 11, 2003			ý		
	CER	RTIFICATE OF MAILING			
I hereby certify that this correspondence i			al Service as first class mail in an enve		

Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be send to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.

FEE TRANSMITTAL For FY 2003 AUG 14 2003 Peg ent Fees are subject to annual revision. TOTAL AMOUNT OF PAYMENT \$168

Complete if Known								
Application Number	09/678,414							
Filing Date	October 2, 2000							
First Named Inventor	David W. Carlson							
Examiner Name	B. Kebede							
Group Art Unit	2823 星 刀							
Attorney Document No.	100-13601 (P04 197-CE)							

-	Mer	HOD OF PA	VMFNT (check one)			•••		FEE CAL	LCULATION (continued)
METHOD OF PAYMENT (check one) 1. ☒ The Commissioner is hereby authorized to charge any fees or credit				3 A	dditiona		PEE CAI	LCULATION (continued)	
any overpayment under 37 CFR 1.16 and 1.17 which may be required			Large B			ll Entity	芸島の		
by this paper to Deposit Account No. 502305				Fee			·	7	
LAW OFFICES OF MARK C. PICKERING					Code	Fee			D 103 103 103 103 103 103 103 103 103 103
☐ Applicant claims small entity status. See 37 CFR 1.27.				1051	130	2051	65	Surcharge - late filing fee or oath	
2. ☐ Payment Enclosed: ☐ Check ☐ Money Order ☐ Other					1052	50	2052	25	Surcharge - late provisional filing fee or cover sheet
FEE CALCULATION					1053	130	1053	130	Non-English specification
1. BASIC FILING FEE					1812	2520	1812	2520	For filing a request for ex parte reexamination
LARGE ENTITY SMALL ENTITY					1804	920	1804	920	Requesting publication of SIR prior to Examiner action
Fee Code	Fee Fe Co		Fee Description	Fee Paid	1805	1840	1805	1840	Requesting publication of SIR after Examiner action
	50 200	375	Utility		1251	110	2251	55	Extension for reply within first month
	30 200		Design		1252	410	2252	205	Extension for reply within second month
	200		Plant		1253	930	2253	465	Extension for reply within third month
	50 2004 60 2003		Reissue		1254	1450	2254	725	Extension for reply within fourth month
1003 1	60 200:	> 8 U	Provisional		1255	1970	2255	985	Extension for reply within fifth month
•			SUBTOTAL (1)		1401	320	2401	160	Notice of Appeal
2. EXTRA	CLAIM FEE	s FOR UT	LITY AND REIS	SUE	1402	320	2402	160	Filing a brief in support of an appeal
		Extra Claims	Fee from below	Fee Paid	1403	280	2403	140	Request for oral hearing
Total Claims	21 - 22 **	= 0	x 18 = \$		1451	1510	1451	1510	Petition to institute a public use proceeding
Independent	5 - 3	= 2	x 84 = \$		1452	110	2452	55	Petition to revive-unavoidable
Multiple Dep			* = \$		1453	1300	2453	650	Petition to revive-unintentional
** or number	· previously pa	id, if greater;	for Reissues, see below:		1501	1300	2501	650	Utility issue fee (or reissue)
Large Entit	Large Entity Small Entity			1502	470	2502	235	Design issue fee	
_	ee Fee Co		Fee Description		1503	630	2503	315	Plant issue fee
,	18 2202	9	Claim in excess of 20)	1460	130	1460	130	Petitions to the Commissioner
1201	84 2201	42	Independent claims i	n excess of 3	1807	50	1807	50	Processing fee under 37 CFR 1.17(q)
	80 2203	140	Multiple dependent o	_	1806	180	1806	180	Submission of Information Disclosure Stmt
	84 2204	42	** Reissue ind. claim patent		8021	40	8021	40	Recording each patent assignment per property (times number of properties)
1205	18 2205	9	** Reissue claims in over original pater		1809	750	2809	375	Filing a submission after final rejection (37 CFR 1.129(a))
					1810	750	2810	375	For each additional invention be examined (37 CFR 1.129(b)
					1801	750	2801	375	Request for Continued Examination (RCE)
					1802	900	1802	900	Request for expedited examination of a design application
			SUBTOTAL (2	2) \$168	*Reduc	ed by Bas	sic Filing	Fee Paid	SUBTOTAL (3) \$0
				SUBMI	TTED	BY		_	
	s of Mark C	Pickering				0	//	_	2
P.O. Box 300				Date: $8 - (1 - 0.3)$					
Petaluma, CA 94953-0300					1.		1 1		
Telephone: (707) 762-5583 Facsimile: (707) 762-5504				- Mal Color					
Customer No. 33402				By: Mark C. Pickering, Pag. No. 26 220					
Customer 110. 33702					Mark C. Pickering, Reg. No. 36,239				



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

David W. Carlson

Appln. No.: 09/678,414

Filed: October 2, 2000

For: METHOD FOR PLANARIZING A THIN

FILM

Group Art Unit: 2823

Examiner: B. Kebede

AMENDMENT UNDER 37 CFR §1.116,

EXPEDITATED PROCEDURE REQUESTED

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action mailed June 9, 2003, please amend the above ad application as follows: identified application as follows:

United States Postal Service, postage prepaid, in an envelope, addressed to Mail Stop AF __ Commissioner for Patents,

P.O. Box 1450, Alexandria, VA 22313-1450 ca 08-11-03

aust 11,2003 By

08/15/2003 JADD01

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168.00 OP

AMENDMENT UNDER 37 CFR §1.116 IN RESPONSE TO (OFFICE ACTION DATED JUNE 9, 2003)

Atty. Docket No. 100-13601 (P04797-C1)

AMENDMENTS TO THE CLAIMS

1. (Previously Amended) A method for forming a planarized layer of material on a processed wafer, the wafer having a top surface, the top surface having spaced-apart wafer upper levels and a wafer lower level that lies between the wafer upper levels, the wafer upper levels lying above the wafer lower level, the method comprising the steps of:

forming a layer of first material on the top surface of the wafer, the layer of first material having a top surface, the top surface of the layer of first material having a first lower level and a first upper level that lies above the first lower level;

forming a layer of second material on the top surface of the layer of first material; and chemically-mechanically polishing the layer of second material and the underlying layer of first material with a slurry until the layer of second material is substantially all removed from the layer of first material to form the planarized layer of material, the planarized layer of material lying over the wafer upper levels and the wafer lower level.

- 2. (Original) The method of claim 1 wherein the first lower level lies above the wafer upper level.
 - 3. Cancelled.
 - 4. Cancelled.
- 5. (Currently Amended) The method of claim 2 wherein the planarized layer of material has a <u>first</u> thickness over the wafer upper level, and

wherein the layer of first material is formed such that the first lower level lies above the wafer upper level by a value second thickness that is equal to a greater than the <u>first</u> thickness.

AMENDMENT UNDER 37 CFR §1.116 IN RESPONSE TO (OFFICE ACTION DATED JUNE 9, 2003)

Atty. Docket No. 100-13601 (P04797-C1)